## **B60/C60** Series

### **Heat Sink System**

Ohmite introduces the power C series heat sink with improved Cam N Lock spring clip (Pat. Pending). This series offers flexible, high performance and compact heat sink with exchangeable cam clip system for TO-220, TO-247, and TO-264 devices. The built in lip is provided for mounting ease. The optional B series can be tapped for popular Ohmite resistors or other devices. These powerful heat sinks can be thru-hole soldered as a single or dual unit. The dual unit can be mated to a 60mm fan for greater thermal performance. It is the ideal type of heat sink for high power density and small size (3U or 4U) electronic packaging with forced convection.



#### SERIES SPECIFICATIONS

Heatsink Part Number	Surface Area (in² / mm²)	Weight (oz / g)	Length L (mm)	consult factory for alternate lengths and clip combinations
C60-075-VE C60-075-AE	177 / 114,300	5.7 / 163	75	
B60-075-VE B60-075-AE	177 / 114,300	5.7 / 163	75	_

#### CHARACTERISTICS

Heat Sink	Aluminum Alloy 6063-T5 or Equivalent with either degreased or black anodized finish.	
Spring Clip	Music Wire, Per ASTM A228 with bright nickel plating	
Solder Foot	Cold-rolled Steel, Per ASTM A-366 with pure tin over copper strike. RoHS compliant.	
Fan	60mm fan with 4 self-tapping M3 screws	
Interface Thermal For improvement, use thermal joint compound, 0.005 Grafoil (TG Resistance 800 by Laird), or phase change material (Hi-Flow by Bergquist) Insulator (Optional) Sil-Pad 900-S. K6 800-S and K10 by Bergqui		

#### **Heat Dissipation**



(continued)



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## **Heat Sink System**

#### DIMENSIONS



#### HOW TO ORDER

Clip



